DATA SHEET

FBL2040
3.3V BTL8-bit TTL to BTL transceiver

Product specification
IC23 Data Handbook

1998 Dec 07

Philips
Semiconductors

PHILIPS

3.3V BTL 8-bit TTL to BTL transceiver FBL2040

FEATURES

- 3.3V version of FB2040A with 70% power savings
- 8-bit BTL transceivers
- Separate I/O on TTL A-port
- Inverting
- Drives heavily loaded backplanes with equivalent load impedances down to 10Ω.
- High drive 100mA BTL open collector drivers on B-port
- Allows incident wave switching in heavily loaded backplane buses
- Reduced BTL voltage swing produces less noise and reduces power consumption
- Built-in precision band-gap reference provides accurate receiver thresholds and improved noise immunity
- Compatible with IEEE Futurebus+ or proprietary BTL backplanes
- Controlled output ramp and multiple GND pins minimize ground bounce
- Each BTL driver has a dedicated Bus GND for a signal return
- Glitch-free power up/power down operation
- Low I_{CC} current
- Tight output skew
- Supports live insertion
- Pins for the optional JTAG boundary scan function are provided
- High density packaging in plastic Quad Flat Pack

QUICK REFERENCE DATA

SYMBOL	PARAMETER		TYPICAL	UNIT
t_{PLH} t_{PHL}	Propagation delay AIn to $\overline{Bn}$		4.4 3.1	ns
t_{PLH} t_{PHL}	Propagation delay $\overline{Bn}$ to AOn		3.4 3.2	ns
C_{OB}	Output capacitance ($\overline{B0}$ – $\overline{B7}$ only)		4	pF
I_{OL}	Output current ($\overline{B0}$ – $\overline{B7}$ only)		100	mA
I_{CC}	Supply current	Standby	4	mA
		AIn to $\overline{Bn}$ (outputs Low)	8	
		$\overline{Bn}$ to AOn (outputs Low)	18	
		AIn to $\overline{Bn}$ (outputs High)	13	
		$\overline{Bn}$ to AOn (outputs High)	16	

ORDERING INFORMATION

PACKAGES	COMMERCIAL RANGE V_{CC} = 3V±10%; T_{amb} = –40°C to +85°C	DRAWING NUMBER
52-pin Plastic Quad Flat Pack (QFP)	FBL2040BB	SOT379-1

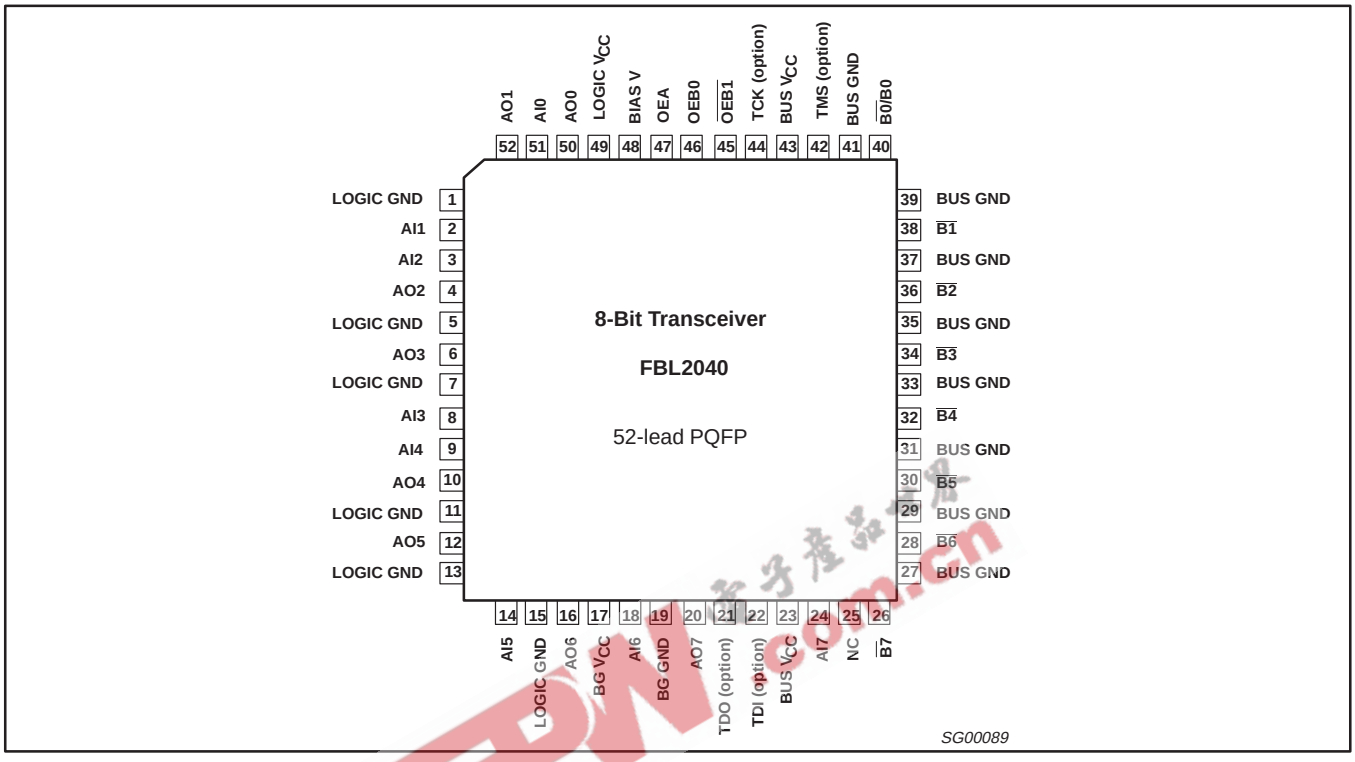
ABSOLUTE MAXIMUM RATINGS

Operation beyond the limits set forth in this table may impair the useful life of the device. Unless otherwise noted these limits are over the operating free-air temperature range.

SYMBOL	PARAMETER		RATING	UNIT
V_{CC}	Supply voltage		-0.5 to +4.6	V
V_{IN}	Input voltage	AI0 – AI7, OEB0, $\overline{OEB1}$, OEA	-0.5 to +7.0	V
		$\overline{B0}$ – $\overline{B7}$	-0.5 to +3.5	
I_{IN}	Input current		-18 to +5.0	mA
V_{OUT}	Voltage applied to output in High output state		-0.5 to +7.0	V
I_{OUT}	Current applied to output in Low output state	A0 – A7	64, –64	mA
		$\overline{B0}$ – $\overline{B7}$	200	
T_{amb}	Operating free-air temperature range		-40 to +85	°C
T_{STG}	Storage temperature		-65 to +150	°C

3.3V BTL 8-bit TTL to BTL transceiver FBL2040

PIN CONFIGURATION



DESCRIPTION

The FBL2040 is an 8-bit bidirectional BTL transceiver and is intended to provide the electrical interface to a high performance wired-OR bus. The FBL2040 is an inverting transceiver.

The B-port drivers are Low-capacitance open collectors with controlled ramp and are designed to sink 100mA. Precision band gap references on the B-port insure very good noise margins by limiting the switching threshold to a narrow region centered at 1.55V.

The B-port interfaces to “Backplane Transceiver Logic” (See the IEEE 1194.1 BTL standard). BTL features low power consumption by reducing voltage swing (1Vp-p, between 1V and 2V) and reduced capacitive loading by placing an internal series diode on the drivers. BTL also provides incident wave switching, a necessity for high performance backplanes.

The A-port operates at TTL levels with separate I/O. The 3-state A-port drivers are enabled when OEA goes High after an extra 6ns delay which is built in to provide a break-before-make function. When OEA goes Low, A-port drivers become High impedance without any extra delay. During power on/off cycles, the A-port drivers are held in a High impedance state when V_{CC} is below 1.3V.

The B-port has two output enables, OEB0 and $\overline{OEB1}$. When OEB0 is High and $\overline{OEB1}$ is Low the output is enabled. When OEB0 is Low or if $\overline{OEB1}$ is High, the B-port is inactive and is at the level of the backplane signal.

To support live insertion, OEB0 is held Low during power on/off cycles to insure glitch free B port drivers. Proper bias for B port drivers during live insertion is provided by the BIAS V pin when at a 3.3V level while V_{CC} is Low. If live insertion is not a requirement, the BIAS V pin should be tied to a V_{CC} pin.

The LOGIC GND and BUS GND pins are isolated in the package to minimize noise coupling between the BTL and TTL sides. These pins should be tied to a common ground external to the package.

Each BTL driver has an associated BUS GND pin that acts as a signal return path and these BUS GND pins are internally isolated from each other. In the event of a ground return fault, a “hard” signal failure occurs instead of a pattern dependent error that may be very infrequent and impossible to trouble-shoot.

The LOGIC V_{CC} and BUS V_{CC} pins are also isolated internally to minimize noise and may be externally decoupled separately or simply tied together.

JTAG boundary scan pins are provided with signals TMS, TCK, TDI and TDO. TMS and TCK are no-connects (no bond wires) and TDI and TDO are shorted together internally. Boundary scan functionality is not implemented at this time.

PIN DESCRIPTION

SYMBOL	PIN NUMBER	TYPE	NAME AND FUNCTION
AI0 – AI7	51, 2, 3, 8, 9, 14, 18, 24	Input	Data inputs (TTL)
AO0 – AO7	50, 52, 4, 6, 10, 12, 16, 20	Output	3-state outputs (TTL)
$\overline{B0}$ – $\overline{B7}$	40, 38, 36, 34, 32, 30, 28, 26	I/O	Data inputs/Open Collector outputs. High current drive (BTL)
OEB0	46	Input	Enables the B outputs when High
$\overline{OEB1}$	45	Input	Enables the B outputs when Low
OEA	47	Input	Enables the A outputs when High
BUS GND	41, 39, 37, 35, 33, 31, 29, 27	GND	Bus ground (0V)
LOGIC GND	1, 5, 7, 11, 13, 15	GND	Logic ground (0V)
BUS V_{CC}	23, 43	Power	Positive supply voltage
LOGIC V_{CC}	49	Power	Positive supply voltage
BG V_{CC}	17	Power	Band Gap threshold voltage reference
BG GND	19	GND	Band Gap threshold voltage reference ground
BIAS V	48	Power	Live insertion pre-bias pin
TMS	42	Input	Test Mode Select (optional, if not implemented then no-connect)
TCK	44	Input	Test Clock (optional, if not implemented then no-connect)
TDI	22	Input	Test Data In (optional, if not implemented then shorted to TDO)
TDO	21	Output	Test Data Out (optional, if not implemented then shorted to TDI)
NC	25	NC	No Connect

FUNCTION TABLE

MODE	INPUTS					OUTPUTS	
	AIn	$\overline{Bn}$*	OEB0	$\overline{OEB1}$	OEA	AOn	$\overline{Bn}$*
AIn to $\overline{Bn}$	L	—	H	L	L	Z	H**
	H	—	H	L	L	Z	L
	L	—	H	L	H	L	H**
	H	—	H	L	H	H	L
Disable $\overline{Bn}$ outputs	X	X	L	X	X	X	H**
	X	X	X	H	X	X	H**
$\overline{Bn}$ to AOn	X	L	L	X	H	H	Input
	X	H	X	H	H	L	Input
	X	L	X	H	H	H	Input
	X	H	L	X	H	L	Input
Disable AOn outputs	—	X	X	X	L	Z	X

H** = Goes to level of pull-up voltage
B* = Precaution should be taken to ensure B inputs do not float. If they do, they are equal to Low state.

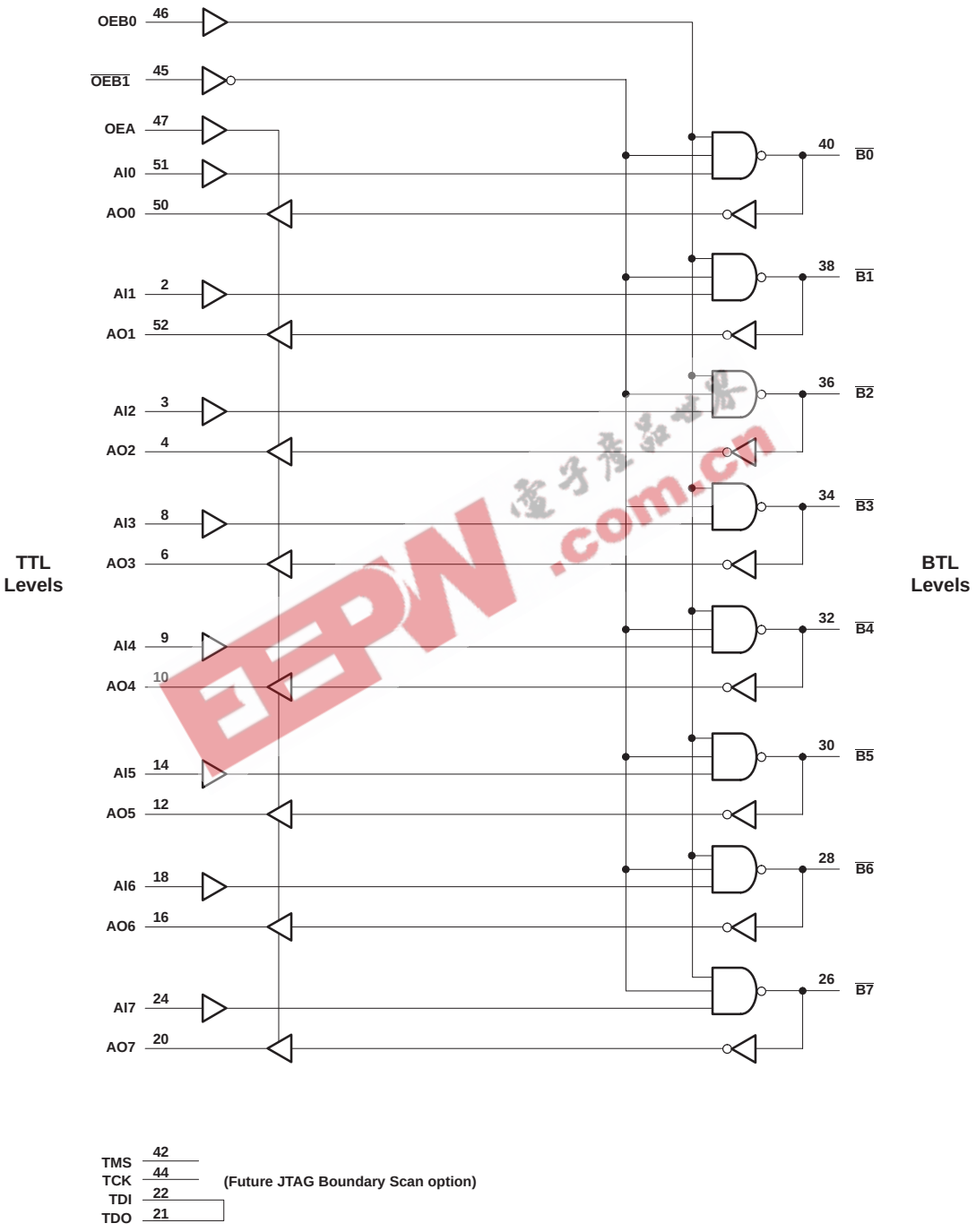
RECOMMENDED OPERATING CONDITIONS

SYMBOL	PARAMETER		LIMITS			UNIT
			MIN	NOM	MAX	
V_{CC}	Supply voltage		3.0	3.3	3.6	V
V_{IH}	High-level input voltage	Except $\overline{B0}$–$\overline{B7}$	2.0			V
		$\overline{B0}$ – $\overline{B7}$	1.62	1.55		
V_{IL}	Low-level input voltage	Except $\overline{B0}$–$\overline{B7}$			0.8	V
		$\overline{B0}$ – $\overline{B7}$			1.47	
I_{IK}	Input clamp current				-18	mA
I_{OH}	High-level output current	AO0 – AO7			-32	mA
I_{OL}	Low-level output current	AO0 – AO7			32	mA
		$\overline{B0}$ – $\overline{B7}$			100	
C_{OB}	Output capacitance on B port			6	7	pF
T_{amb}	Operating free-air temperature range		–40		+85	°C

LIVE INSERTION SPECIFICATIONS

SYMBOL	PARAMETER		LIMITS			UNIT
			MIN	TYP	MAX	
V_{BIASV}	Bias pin voltage	Voltage difference between the Bias voltage and V_{CC} after the PCB is plugged in.	–	–	0.5	V
I_{BIASV}	Bias pin (I_{BIASV}) input DC current	V_{CC} = 0 V, Bias V = 3.6V			1.2	mA
		V_{CC} = 3.3V, Bias V = 3.6V			10	µA
$V_{\overline{Bn}}$	Bus voltage during prebias	$\overline{B0}$ – $\overline{B8}$ = 0V, Bias V = 3.3V	1.62		2.1	V
I_{LM}	Fall current during prebias	$\overline{B0}$ – $\overline{B8}$ = 2V, Bias V = 1.3 to 2.5V			1	µA
I_{HM}	Rise current during prebias	$\overline{B0}$ – $\overline{B8}$ = 1V, Bias V = 3 to 3.6V	-1			µA
$I_{\overline{Bn}PEAK}$	Peak bus current during insertion	V_{CC} = 0 to 3.3V, $\overline{B0}$ – $\overline{B8}$ = 0 to 2.0V, Bias V = 2.7 to 3.6V, OEB0 = 0.8V, t_r = 2ns			10	mA
$I_{OL}OFF$	Power up current	V_{CC} = 0 to 3.3V, OEB0 = 0.8V			100	µA
		V_{CC} = 0 to 1.2V, OEB0 = 0 to 5V			100	
t_{GR}	Input glitch rejection	V_{CC} = 3.3V	1.0	1.35		ns

LOGIC DIAGRAM FOR FBL2040



NC = 25
LOGIC V_{CC} = 49
LOGIC GND = 1, 5, 7, 11, 13, 15
BUS V_{CC} = 23, 43
BUS GND = 27, 29, 31, 33, 35, 37, 39, 41
BIAS V = 48
BG V_{CC} = 17
BG GND = 19

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DC ELECTRICAL CHARACTERISTICS

Over recommended operating free-air temperature range unless otherwise noted.

symbol	parameter		test conditions[1]	limits			unit
				min	typ[2]	max	
I_{OH}	High level output current	$\overline{B0}$ – $\overline{B7}$	V_{CC} = MAX, V_{IL} = MAX, V_{OH} = 1.9V			100	µA
I_{OFF}	Power-off output current	$\overline{B0}$ – $\overline{B7}$	V_{CC} = 0V, V_{IL} = MAX, V_{OH} = 1.9V			100	µA
			V_{CC} = 0V, V_{IL} = MAX, V_{OH} = 1.9V@85°C			300	
V_{OH}	High-level output voltage	AO0 – AO7[3]	V_{CC} = MIN to MAX; I_{OH} = -100µA	V_{CC} –0.2			V
			V_{CC} = MIN; I_{OH} = -8mA	2.4			V
			V_{CC} = MIN; I_{OH} = -32mA	2.0			V
V_{OL}	Low-level output voltage	AO0 – AO7[3]	V_{CC} = MIN; I_{OL} = 16mA			0.4	V
			V_{CC} = MIN; I_{OL} = 32mA			0.5	V
		$\overline{B0}$ – $\overline{B7}$	V_{CC} = MIN, I_{OL} = 4mA	0.5			V
			V_{CC} = MIN, I_{OL} = 100mA	0.75	1.0	1.20	
V_{IK}	Input clamp voltage		V_{CC} = MIN, I_I = I_{IK} = –18mA		–0.85	-1.2	V
I_I	Input leakage current	Control pins	V_{CC} = 3.6V; V_I = V_{CC} or 100mV			±1.0	µA
		Control/ AI0 – AI7	V_{CC} = 0V or 3.6V; V_I = 5.5V			10	
		AI0 – AI7	V_{CC} = 3.6V; V_I = V_{CC}			1	
		Note 4	V_{CC} = 3.6V; V_I = 100mV			–5	
I_{IH}	High-level input current	$\overline{B0}$ – $\overline{B7}$	V_{CC} = MAX, V_I = 1.9V			100	µA
			V_{CC} = MAX, V_I = 3.5V, note 5	100			mA
			V_{CC} = MAX, V_I = 3.75V, Note 5 @ –40°C	100			
I_{IL}	Low-level input current	$\overline{B0}$ – $\overline{B7}$	V_{CC} = MAX, V_I = 0.75V			-100	µA
I_{OZH}	Off-state output current	AO0 – AO7	V_{CC} = MAX, V_O =3V			5	µA
I_{OZL}	Off-state output current	AO0 – AO7	V_{CC} = MAX, V_O = 0.5V			-5	µA
I_{CCZ}	Supply current		V_{CC} = MAX, outputs disabled, V_I = GND or 0.0		16	31	mA
I_{CCH} I_{CCL}	Supply current (total)	B→A	V_{CC} = MAX, outputs High, V_I = GND or 0.0		16	35	
			V_{CC} = MAX, outputs Low, V_I = GND or 0.0		18	39	
I_{CCH} I_{CCL}	Supply current (total)	A→B	V_{CC} = MAX, outputs High, V_I = GND or 0.0		13	30	
			V_{CC} = MAX, outputs Low, V_I = GND or 0.0		8	16	

NOTES:

1. For conditions shown as MIN or MAX, use the appropriate value specified under recommended operation conditions for the applicable type.
2. All typical values are at V_{CC} = 3.3V, T_A = 25°C.
3. Due to test equipment limitations, actual test conditions are V_{IH} = 1.8V and V_{IL} = 1.3V for the B side.
4. Unused pins are at V_{CC} or GND.
5. For B port input voltage between 3 and 5 volt; I_{IH} will be greater than 100mA but the part will continue to function normally (clamping circuit is Active). This is not a tested condition.

AC ELECTRICAL CHARACTERISTICS INDUSTRIAL AND COMMERCIAL (A TO B)

SYMBOL	PARAMETER	TEST CONDITION	T_{amb} = +25°C, V_{CC} = 3.3V, R_L = 9Ω			T_{amb} = –40 to +85°C, V_{CC} = 3.3V±10%, R_L = 9Ω		UNIT
			MIN	TYP	MAX	MIN	MAX	
t_{PLH} t_{PHL}	Propagation delay, AIn to $\overline{B}$n		1.0 1.2	2.7 3.0	5.7 5.1	1.0 1.0	6.3 5.6	ns
t_{PLH} t_{PHL}	OEB0 to $\overline{B}$n		1.4 2.0	3.1 4.1	5.0 6.4	1.0 1.9	6.1 6.9	ns
t_{PLH} t_{PHL}	$\overline{OEB1}$ to $\overline{B}$n		1.5 1.4	3.3 3.2	5.3 5.0	1.0 1.1	6.0 5.8	ns
t_{TLH} t_{THL}	Transition time, $\overline{B}$n Port (1.3V to 1.8V)		1.0 1.2	1.7 1.9	2.5 2.5	0.5 0.5	3.0 3.0	ns
$t_{SK}(O)$	Output skew between receivers in same package		0.5	1.0			1.5	ns
$t_{SK}(P)$	Pulse skew $\lvert t_{PHL} - t_{PLH} \rvert$ MAX		0.3	1.0			1.5	ns

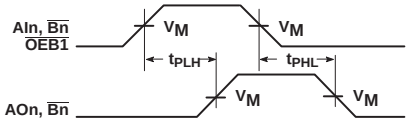
AC ELECTRICAL CHARACTERISTICS INDUSTRIAL AND COMMERCIAL (A TO B)

SYMBOL	PARAMETER	TEST CONDITION	T_{amb} = +25°C, V_{CC} = 3.3V, R_L = 16.5Ω			T_{amb} = –40 to +85°C, V_{CC} = 3.3V±10%, R_L = 16.5Ω		UNIT
			MIN	TYP	MAX	MIN	MAX	
t_{PLH} t_{PHL}	Propagation delay, AIn to $\overline{B}$n		1.2 1.2	2.8 2.8	4.4 4.6	1.0 1.1	5.2 5.1	ns
t_{PLH} t_{PHL}	OEB0 to $\overline{B}$n		1.8 1.8	3.6 3.8	5.6 5.9	1.2 1.7	6.5 6.3	ns
t_{PLH} t_{PHL}	$\overline{OEB1}$ to $\overline{B}$n		1.6 1.3	3.4 3.0	6.2 4.8	1.0 1.0	6.0 5.6	ns
t_{TLH} t_{THL}	Transition time, $\overline{B}$n Port (1.3V to 1.8V)		1.0 1.2	1.7 1.9	2.5 2.5	0.5 0.5	3.0 3.0	ns
$t_{SK}(O)$	Output skew between receivers in same package		0.5	1.0			1.5	ns
$t_{SK}(P)$	Pulse skew $\lvert t_{PHL} - t_{PLH} \rvert$ MAX		0.3	1.0			1.5	ns

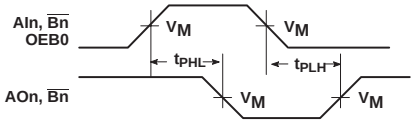
AC ELECTRICAL CHARACTERISTICS INDUSTRIAL AND COMMERCIAL (B TO A)

SYMBOL	PARAMETER	TEST CONDITION	T_{amb} = +25°C, V_{CC} = 3.3V			T_{amb} = –40 to +85°C, V_{CC} = 3.3V±10%		UNIT
			MIN	TYP	MAX	MIN	MAX	
t_{PLH} t_{PHL}	Propagation delay, $\overline{B}$n to AOn		1.5 1.7	3.4 3.6	5.4 5.5	1.3 1.5	6.1 6.8	ns
t_{PLH} t_{PHL}	OEA to AOn		2.1 2.0	4.0 3.7	5.9 5.5	1.9 1.4	6.5 6.5	ns
t_{PLH} t_{PHL}	OEA to AOn		2.0 1.0	1.8 1.0	5.9 4.3	1.8 1.0	6.2 4.8	ns
t_{TLH} t_{THL}	Transition time, AOn Port (10% to 90% or 90% to 10%)		1.3 1.7	2.2 2.6	2.5 2.5	0.9 0.8	3.0 3.0	ns
$t_{SK}(O)$	Output skew between receivers in same package		0.5	1.0			1.5	ns
$t_{SK}(P)$	Pulse skew $\lvert t_{PHL} - t_{PLH} \rvert$ MAX		0.3	1.0			1.5	ns

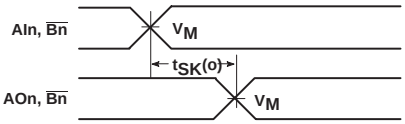
AC WAVEFORMS



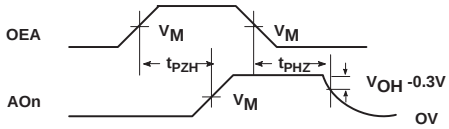
Waveform 1. Propagation Delay for Data or Output Enable to Output



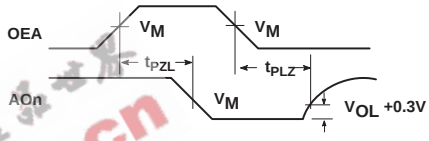
Waveform 2. Propagation Delay for Data or Output Enable to Output



Waveform 3. Output Skews



Waveform 4. 3-State Output Enable Time to High Level and Output Disable Time from High Level



Waveform 5. 3-State Output Enable Time to Low Level and Output Disable Time from Low Level

NOTE: V_M = 1.55V for $\overline{Bn}$, V_M = 1.5V for all others.

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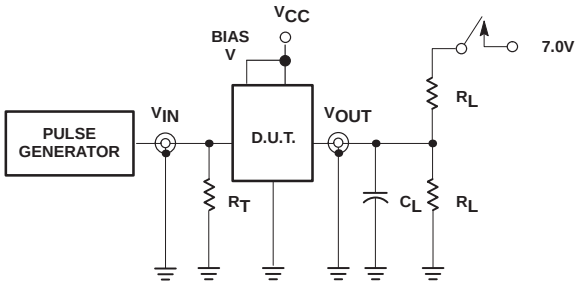
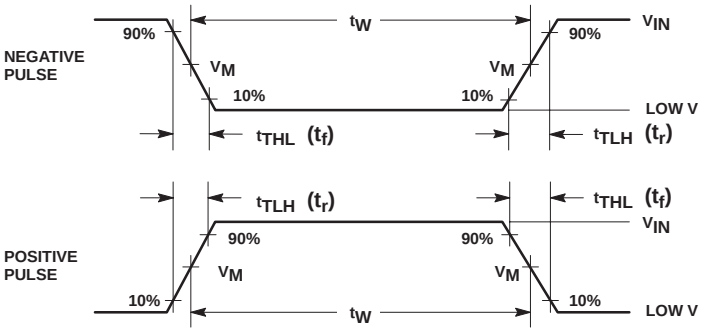
TEST CIRCUIT AND WAVEFORMS



Test Circuit for 3-State Outputs on A Port



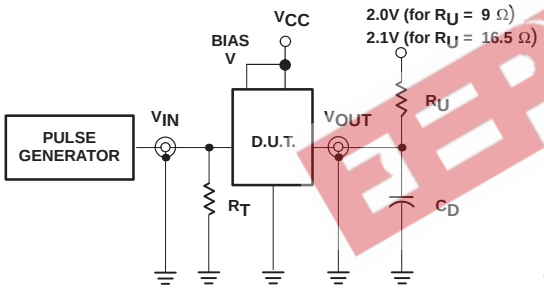
V_M = 1.55V for $\overline{Bn}$, V_M = 1.5V for all others.

Input Pulse Definitions

SWITCH POSITION

TEST	SWITCH
t_{PLZ}, t_{PZL}	closed
All other	open

Family	INPUT PULSE REQUIREMENTS					
FB+	Amplitude	Low V	Rep. Rate	t_W	t_{TLH}	t_{THL}
A Port	3.0V	0.0V	1MHz	500ns	2.5ns	2.5ns
B Port	2.0V	1.0V	1MHz	500ns	2.5ns	2.5ns



Test Circuit for Outputs on B Port

DEFINITIONS:

R_L = Load Resistor; see AC CHARACTERISTICS for value.
C_L = Load capacitance includes jig and probe capacitance; see AC CHARACTERISTICS for value.
R_T = Termination resistance should be equal to Z_{OUT} of pulse generators.
C_D = Load capacitance includes jig and probe capacitance; see AC CHARACTERISTICS for value.
R_U = Pull up resistor; see AC CHARACTERISTICS for value.

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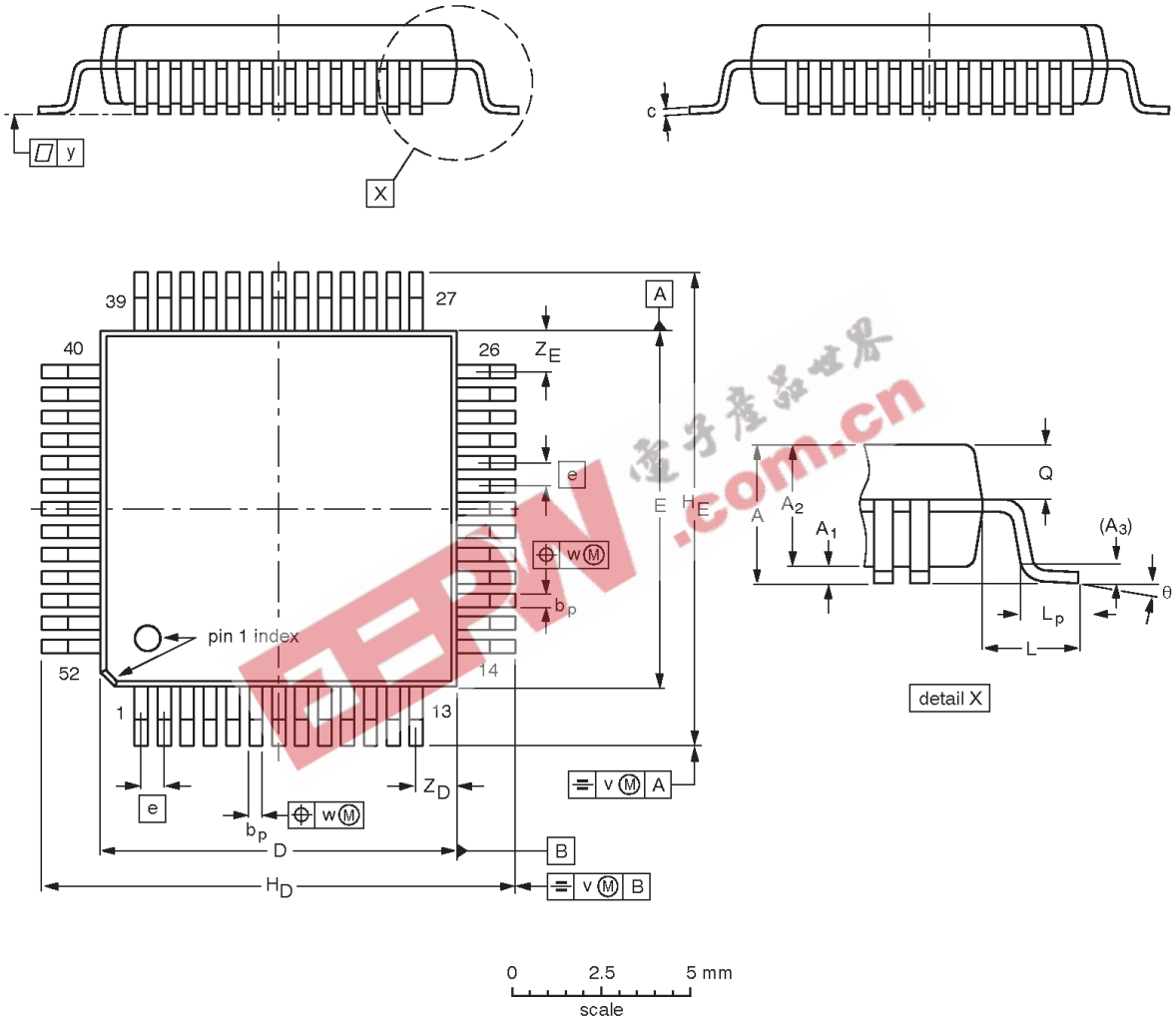
QFP52: plastic quad flat package; 52 leads (lead length 1.6 mm); body 10 x 10 x 2.0 mm SOT379-1



DIMENSIONS (mm are the original dimensions)

UNIT	A max.	A_1	A_2	A_3	b_p	c	$D^{(1)}$	$E^{(1)}$	e	H_D	H_E	L	L_p	Q	v	w	y	$Z_D^{(1)}$	$Z_E^{(1)}$	θ
mm	2.45	0.45 0.25	2.10 1.95	0.25	0.38 0.22	0.23 0.13	10.1 9.9	10.1 9.9	0.65	13.45 12.95	13.45 12.95	1.60	0.95 0.65	1.05 0.90	0.20	0.12	0.10	1.24 0.95	1.24 0.95	7° 0°

Note

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ			
SOT379-1		MO-108				95-02-04

3.3V BTL 8-bit TTL TO BTL transceiver 74FBL2040

Data sheet status

Data sheet status	Product status	Definition [1]
Objective specification	Development	This data sheet contains the design target or goal specifications for product development. Specification may change in any manner without notice.
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